

COMPACT CORE
MODULE WITH
WIRELESS AND WIRED
CONNECTIVITY



DIGI CONNECTCARD FOR i.MX28

Cost-effective small-footprint System-on-Module solution delivers performance, low-power operation and integrated 802.11a/b/g/n, Bluetooth 4.0 and Ethernet connectivity

Based on the NXP i.MX28 processor family, **Digi ConnectCard™ for i.MX28** is an ideal embedded platform solution for connected applications in medical and healthcare, energy, transportation and industrial/building automation.

It offers easy design integration and unique peripheral/ interface flexibility in an extremely compact and cost-effective form factor. This module is suitable for a wide range of different devices, including battery powered product designs.

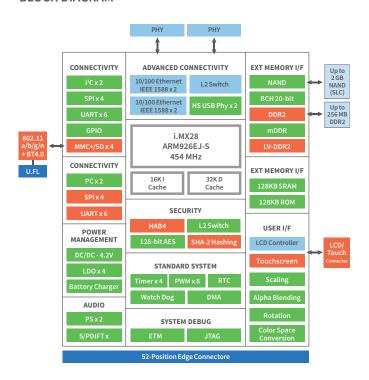
The module is equipped with a highly integrated 32-bit ARM core running at up to 454 MHz, on-chip power management, dual Ethernet and 802.11a/b/g/n networking options, Bluetooth® 4.0 connectivity, dual FlexCAN options, GPIO, ADC, UART, USB high-speed, SPI, I2C, I2S, 1-Wire, PWM and JTAG/ETM.

The Digi JumpStart Kit* for Digi Embedded Linux provides a complete turnkey embedded development solution allowing immediate and successful product development with accelerated time-to-market and reduced design risk.

BENEFITS

- Cost-effective design in compact form factor
- 32-bit ARM processor at up to 454 MHz
- Single/dual 10/100 Ethernet connectivity options
- Pre-approved 802.11a/b/g/n Wi-Fi + Bluetooth 4.0
 - Includes Wi-Fi Access Point mode + Wi-Fi Direct™
 - Support for Bluetooth 3.0 + HS and Bluetooth LE
 - Ready for Cisco CCX and Wi-Fi Logo certification
- Digi Embedded Linux platform
 - Digi Remote Manager® enabled
 - Includes complete Digi BSP source code
- Long-term product availability
- Additional Zigbee, 802.15.4, cellular and satellite connectivity options (off-module)

BLOCK DIAGRAM



RELATED PRODUCTS











ConnectCore® 6

onnectCore® ConnectCore® 6 for i.MX53 SBC

6 Digi XBee

Development

OVERVIEW	ConnectCard i.MX28 ConnectCard Wi-i.MX28		
PROCESSOR			
PROCESSOR MODELS	NXP* i.MX280, i.MX287		
SPEED GRADE	Up to 454 MHz		
CORE TYPE	ARM926EJ-S		
CACHE MEMORY	16k I-Cache, 32k D-Cache		
INTERNAL RAM	128 KB SRAM		
INTERNAL ROM (OCOTP)	1,280 Bits		
MEMORY			
FLASH	Up to 2 GB NAND flash		
RAM	Up to 256 MB DDR2		
DEBUG			
JTAG	Yes		
ETM/ETB	Yes		
POWER MANAGEMENT			
POWER MODES	Run, Standby, Deep Sleep		
WAKE-UP EVENTS	RTC, GPIO, CAN, USB, Ethernet		
AUTO SLOW	Yes		
LI-ION BATTERY CHARGER / MONITOR	Yes		
CLOCK AND WATCHDOG			
REAL-TIME CLOCK	Yes		
ALARM	Yes		
WATCHDOG	Yes		
SECURITY			
DATA CO-PROCESSOR (DCP)	128-bit AES encryption; SHA-1 / SHA256 hashing		
FUSEBOX (OCOTP)	1280 bits		
HIGH-ASSURANCE BOOT (HAB4)	Yes		
SECURE BOOT	128-bit AES decryption		
PERIPHERALS			
UART	Up to 4 channels with bit rates up to 3.25 Mbps (AUART) Up to 1 channel with bit rate up to 115 kbps (DUART)		
CAN BUS	Up to 2 channels, CAN Bus 2.0B, bit rates up to 1 Mbps, 64 message buffers (0-8 bytes), low-power modes with wake-up		
SPI	Up to 2, master/slave modes		
I2S	Up to 1		
I2C	Up to 2 channels, master/slave (7-/10-bit addressing), standard (100 kbps) and fast (400 kbps) mode		
SD/SDIO/MMC	Up to 4 ports, 1-/4-/8-bit modes, up to 48 MHz		
USB 2.0 HIGH-SPEED	Up to 1 USB 2.0 High-Speed Host (with PHY); Up to 1 USB 2.0 OTG port (with PHY)		
1-WIRE	Maxim DS2482-100+		
PWM	Up to 4		
ADC	HSADC: Up to 1 channel, up to 2 Mbps sample rate, 8-/10-/12-bit resolution LRADC: Up to 6 channels, 12-bit resolution		
GPIO	Up to 128 GPIOs, selectable voltage (1.8/3.3 V), interrupt capable		



SPECIFICATIONS	ConnectCard i.MX28	ConnectCard Wi-i.MX28
DISPLAY		
RESOLUTION	800x480 (WVGA)	
REFRESH RATE	Up to 60 Hz	
COLOR DEPTH	8/16/24 bpp	
MODES	RGB/DOTCK/SYSTEM	
COLOR SPACE CONVERSION	Yes	
SCALING	Yes	
ROTATION	Yes	
TOUCH SCREEN		
TOUCH SCREEN CONTROLLER	4-/5-wire (LRADC)	
ETHERNET		
PHYSICAL LAYER	10/100Base-T	
DATA RATES	10/100 Mbps, auto-sensing	
DUPLEX MODE	Full or half duplex, auto-sensing	
IEEE 1588	Yes (i.MX287 only)	
POWER OVER ETHERNET (802.3AF)		
POWER OVER ETHERNET	Development board ready for 802.3af PoE application kit	(sold separately)
WI-FI ²		
STANDARD	N/A	802.11a/b/g/n
ANTENNA CONNECTORS	N/A	2 x U.FL
DUAL DIVERSITY	N/A	Yes
FREQUENCY BANDS	N/A	2.412 - 2.484 GHz; 4.900 - 5.850 GHz
DATA RATES	N/A	802.11b: 1, 2, 5.5, 11 Mbps 802.11a/g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: 15, 30, 45, 60, 90, 120, 135, 150 Mbps (HT40, MCS 0-7)
MODULATION	N/A	DBPSK, DQPSK, CCK, BPSK, QPSK, 16-QAM, 64-QAM
TRANSMIT POWER (±2 DBM)	N/A	802.11b: 17 dBm typical 802.11g/n: 15 dBm typical 802.11a/n: 12 dBm typical
SECURITY	N/A	WEP, WPA-PSK/WPA2-Personal, WPA/WPA2 Enterprise, 802.11i
WI-FI LOGO CERTIFICATION	N/A	Ready
CCXV4 ASD	N/A	Ready
BLUETOOTH ²		
MODES	N/A	Bluetooth 4.0 (Bluetooth 2.1 + EDR, Bluetooth 3.0 + HS 802.11 AMP, Bluetooth Low Energy)
CLASS	N/A	1.5
PROFILES	N/A	GAP, SPP, HSP, HFP, FTP, PAN, OPP, HID, A2DP, AVRCP, HDP
COEXISTENCE	N/A	Yes

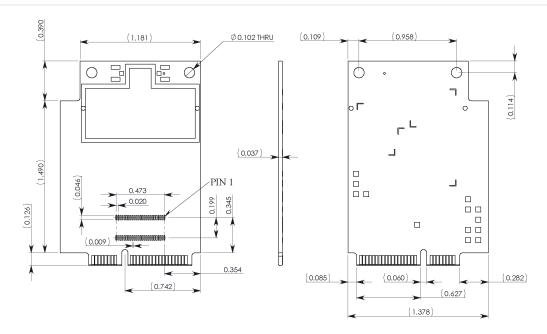


SPECIFICATIONS	ConnectCard i.MX28	ConnectCard Wi-i.MX28
POWER REQUIREMENTS (USE-CASE ESTIMATES)		
WI-FI 2.4 GHZ TRANSMIT, CPU 454 MHZ @ 50%, UART ACTIVE	406 mA at 5V	
WI-FI 2.4 GHZ RECEIVE, CPU IDLE (AUTO SLOW)	100 mA at 5V	
WI-FI STANDBY (SLEEP), CPU STANDBY (IRQ)	8 mA at 5V	
WI-FI STANDBY (HOST OFF), CPU DEEP SLEEP (RTC)	112 μA at 5V	
MODULE VARIANTS ¹		
POPULATION OPTIONS	Processor models (i.MX280, i.MX281, i.MX283, i.MX285, i.MX286, i.MX287), flash, RAM, Single 10/100 Ethernet, dual 10/100 Ethernet w/1588, 802.11a/b/g/n Wi-Fi with Bluetooth 4.0, 1-Wire, LCD connector, CAN bus	
MECHANICAL		
DIMENSIONS (L X W X H) W/O JTAG/LCD CONNECTOR	51 mm x 35 mm x 2.6 mm (2.01 in x 1.38 in x 0.1 in)	51 mm x 35 mm x 3 mm (2.01 in x 1.38 in x 0.12 in)
MATING CONNECTOR FOR MODULE	Molex, P/N 67910-5700; Tyco, P/N 2041119-x	
RETAINING CLIP FOR MODULE (OPTIONAL)	Molex, P/N 480995701; Tyco, P/N 1717832	
JTAG/LCD CONNECTOR ON MODULE (OPTIONAL)	FCI, P/N SFV31R-1STE1LF; Tyco, P/N 3-1734839-1	
ENVIRONMENTAL		
OPERATING TEMPERATURE	-40 °C up to 85 °C (-40 °F to 185 °F) Upper temperature ceilings may require active and/or passive thermal management such as lower clock speed, thermal pads, airflow, etc.	
STORAGE TEMPERATURE	-40 °C up to 85 °C (-40 °F to 185 °F)	
RELATIVE HUMIDITY	5% to 90% (non-condensing)	
APPROVALS AND CERTIFICATIONS		
EMISSIONS	FCC Part 15 Class B, EN 55022 Class B, EN 61000-3-2, EN 61000-3-3, ICES-003 Class B, VCCI Class II, AS 3548, FCC Part 15 Subpart C Section 15.247, IC (Industry Canada), RSS-210 Issue 5 Section 6.2.2(o), EN 300 328, EN 301 489-17	
IMMUNITY	EN 55024, EN 301 489-3	
SAFETY	UL/UR, or equivalent	
RADIO	US, Canada, EU, Japan, Australia/New Zealand	
TEMPERATURE	IEC 60068-2-1, IEC 60068-2-2, IEC 60068-2-78	
VIBRATION/SHOCK	IEC 60068-2-6, IEC 60068-2-64, IEC 60068-2-27	
DESIGN TEST	HALT	
WARRANTY		
PRODUCT WARRANTY	3-year	

All options available on development module. Production modules may require custom variants. Contact your local distributor or Digi sales office for details. Transmit power and channel availability depending on regulatory requirements and corresponding module variants.



PRODUCT DIMENSIONS



PART NUMBERS	DESCRIPTION
KITS	
CC-WMX28-ANDRD	ConnectCore for i.MX28 JumpStart Kit for Android (ICS), installation and setup support package, 7" WVGA LCD panel with capacitive touch screen
MODULES	
CC-WMX-PF47-VM	ConnectCard for i.MX28 module, i.MX287, 454 MHz, up to 85 °C, 128 MB flash, 128 MB DDR2, 802.11a/b/g/n, Ethernet, LCD
CC-MX-PF58-ZK	ConnectCore for i.MX28 module, i.MX287, 454 MHz, up to 85 °C, 256 MB flash, 256 MB DDR2, dual Ethernet, LCD

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